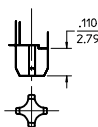


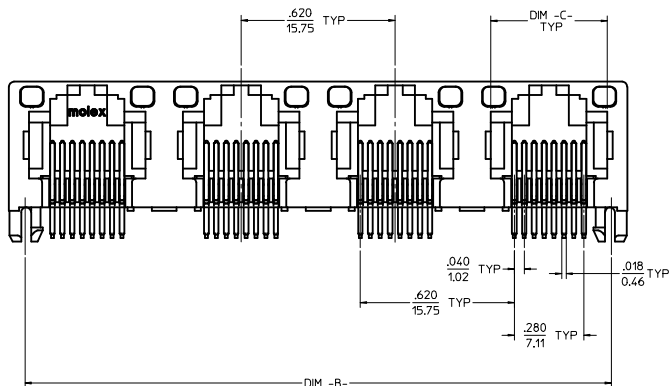
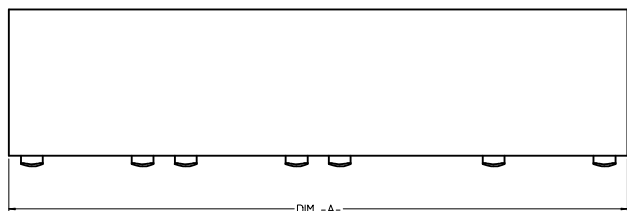
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8

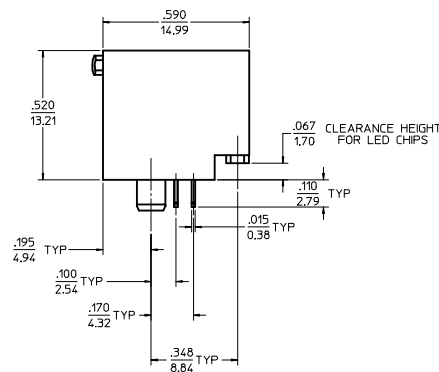


(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



UNSHIELDED
WITH LIGHT PIPES



8 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0001	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0002	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0005	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0006	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

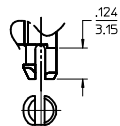
6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0009	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0010	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0011	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0012	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0017	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0018	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0019	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0020	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

- NOTES:
1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
2) FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
5) APPLICATION SPECIFICATION: AS-43860-001
6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
8) MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

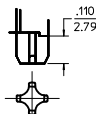
CHGNO 0117 TO 0119 EC NO: UCP2009-1482 DRAWN BY: KLOSTNER 2008/12/10 CHKD BY: IELL 2008/12/10 APPROVED BY: SMITH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED):		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
		mm		INCH		DRAWN BY MAYO 98/10/06		
		4 PLACES ±---		±---		DATE 98/10/06		
		3 PLACES ±---		±.010		DATE 98/10/06		
2 PLACES ±0.25		±---		APPROVED BY ROBERTS 98/10/06				
1 PLACE ±---		±---		DATE 98/10/06				
ANGULAR ±1/2°				MATERIAL NO. SEE CHART				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				DOCUMENT NO. SD-44248-001				
				SHEET NO. 1 OF 6				

MOLEX INCORPORATED
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



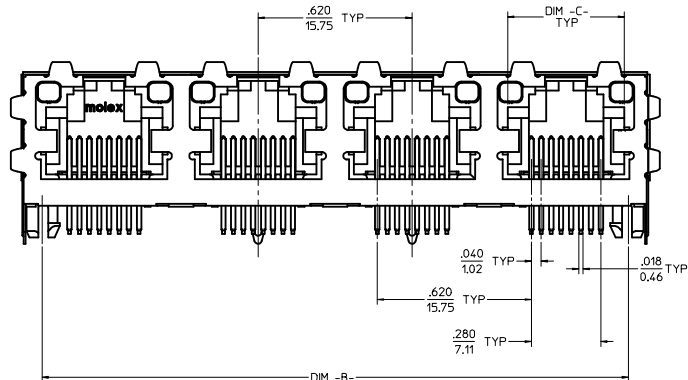
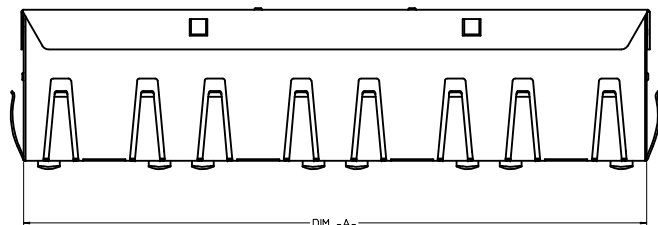
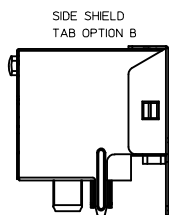
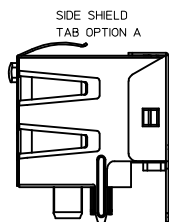
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



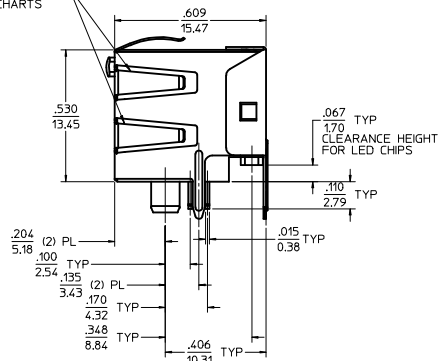
(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



SHIELDED
WITH LIGHT PIPES

OPTIONAL SIDE
SHIELD TABS
SEE CHARTS



(8) CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0029	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0030	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
44248-0033	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0034	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92

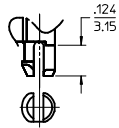
(6) CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0037	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0038	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0039	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0040	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0045	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0046	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0047	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0048	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

NOTES:

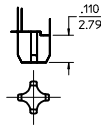
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
- FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (254 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
SHIELD:
*100 MICROINCHES (254 MICROMETERS) NICKEL OVER 50 MICROINCHES (127 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
- PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
- PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
- APPLICATION SPECIFICATION: AS-43860-001
- ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
- PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

SEE SHEET 1 DEC NO: UCP2009-1482 DRAWN: KLOSTERER 2008/12/10 CHKD: BELL 2008/12/10 APPROV: SMITH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED):		DIMENSION STYLE		SCALE		DESIGN UNITS		THIRD ANGLE PROJECTION	
					IN/MM		4:1		INCH		⊙ □	
					mm INCH		DRAWN BY DATE		TITLE			
			4 PLACES ±.005		MMAYO 98/10/06		GANGED INVERTED MODJACK ASSEMBLY		MOLEX MOLEX INCORPORATED		SHEET NO. 2 OF 6	
			3 PLACES ±.010		CHECKED BY DATE							
2 PLACES ±.025		JROBERTS 98/10/06		APPROVED BY DATE								
1 PLACE ±.050		JROBERTS 98/10/06		MATERIAL NO.		DOCUMENT NO.						
ANGULAR ±1/2°				SEE CHART		SD-44248-001						
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SNAP-FIT PEG OPTION

SCALE: NTS.
SEE NOTE #7



PRESS-FIT PEG OPTION

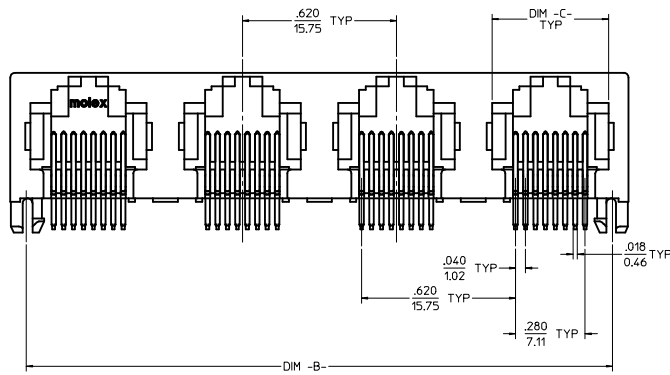
SCALE: NTS.
SEE NOTE #7

8 CIRCUIT HOUSING(S)

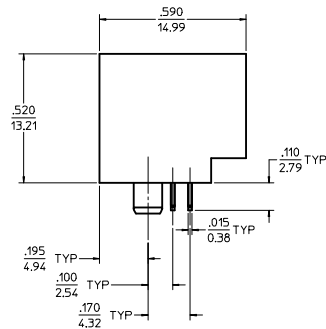
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0057	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0058	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0061	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0062	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0065	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0066	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0067	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0068	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0073	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0074	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0075	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0076	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

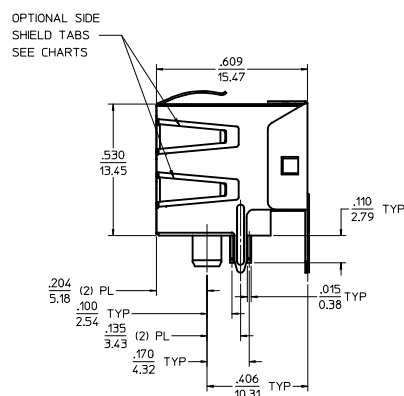
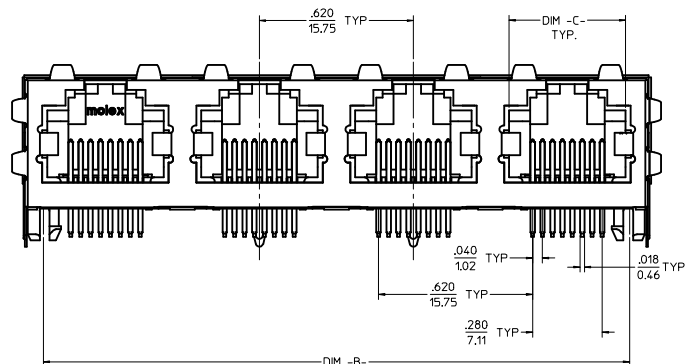
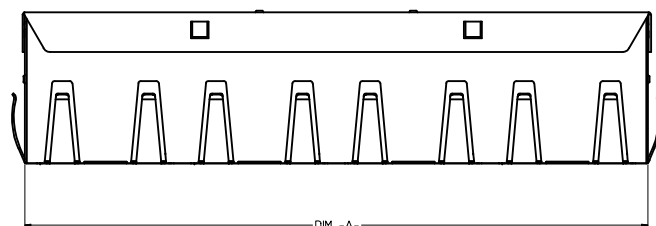
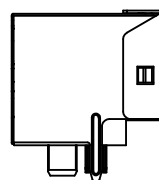
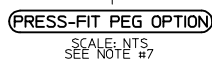
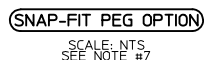


UNSHIELDED



- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
 - FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

SEE SHEET 1 REV C4	DESCRIPTION QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	TITLE GANGED INVERTED MODJACK ASSEMBLY	
		mm	INCH	DRAWN BY MAYO	DATE 98/10/06	TITLE				
		4 PLACES ± .010	± .010	CHECKED BY JROBERTS	DATE 98/10/06	MOLEX MOLEX INCORPORATED				
		3 PLACES ± .010	± .010	APPROVED BY JROBERTS	DATE 98/10/06	MATERIAL NO. DOCUMENT NO.				
		2 PLACES ± 0.25	± 0.25	SD-44248-001						
1 PLACE ± .010	± .010	SHEET NO. 3 OF 6								
ANGULAR ± 1/2°		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS										



(8) CIRCUIT HOUSING(S)								
X = NOT TOOLED	ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
	44248-0085	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0086	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
	44248-0089	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0090	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
X	44248-0119	8	4	PRESS FIT	B	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0093	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0094	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0095	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0096	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0101	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0102	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0103	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0104	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

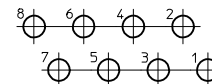
- NOTES:
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICRONS (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICRONS (254 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICRONS (127 MICROMETERS) MIN.
SHIELD:
*100 MICRONS (254 MICROMETERS) NICKEL OVER 50 MICRONS (127 MICROMETERS)
COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX I OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AVOID SHIELD.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
 - 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - 7) MODULAS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 8) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-499-002

SHIELDED

CHGD 0117 TO 0119 EC NO.: UCT2009-1482 DRAWN: KJUDSTEN PER 2008/12/10 CHECKED: BELL 2008/12/10 APPR'D: SELL 2008/12/10	QUALITY SYMBOLS ▼=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± .005 ± .002 3 PLACES ± .010 ± .005 2 PLACES ± .025 ± .010 1 PLACE ± .050 ± .020 ANGULAR ±1/2°	DIMENSION STYLE IN/MM DRAWN BY: MMAYO 98/10/06 CHECKED BY: JROBERTS 98/10/06 APPROVED BY: JROBERTS 98/10/06 MATERIAL NO.	SCALE: 4:1 DESIGN UNITS: INCH THIRD ANGLE PROJECTION	TITLE GANGED INVERTED MODJACK ASSEMBLY MOLEX MOLEX INCORPORATED SD-44248-001	SHEET NO. 4 OF 6
	DESCRIPTION DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01

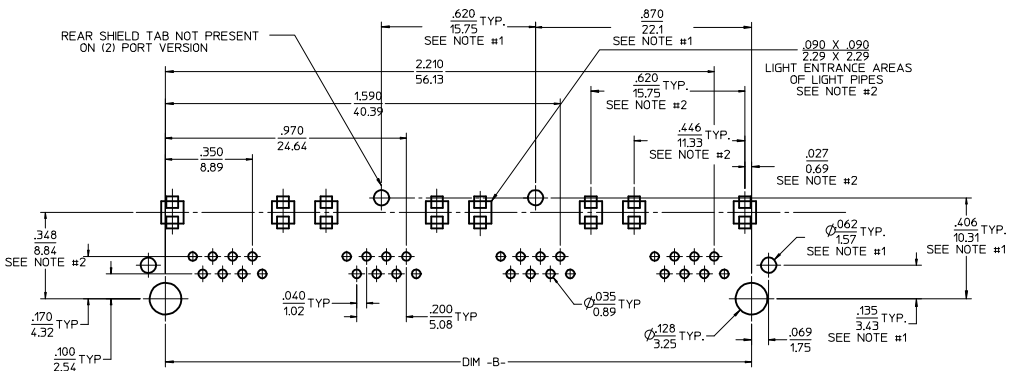


TYPICAL PC TERMINAL HOLE LAYOUT
(8) CIRCUIT CONFIGURATION
SCALE: 10:1

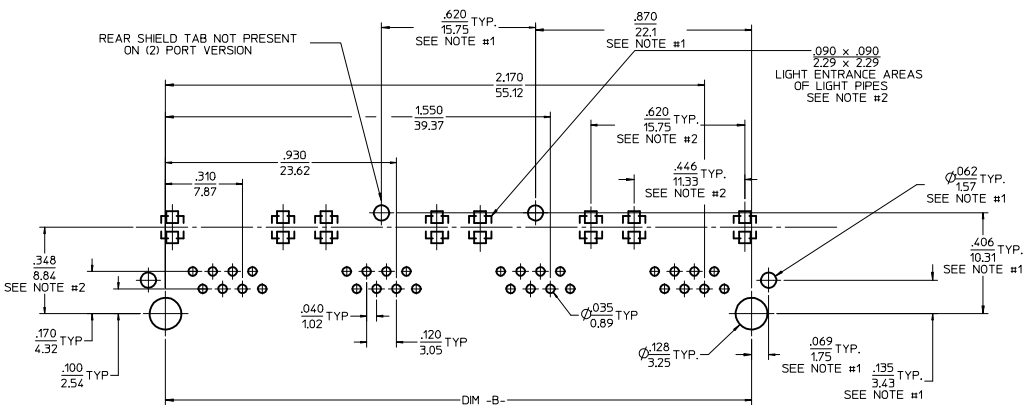
NOTES:

- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH THE SHIELDING OPTION INCLUDED
- 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
- 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

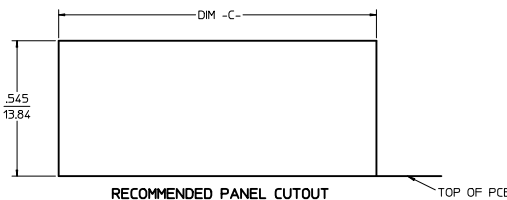
SEE SHEET 1 EC NO: UCP2005-1482 DRAWING: MOLEX EPR 2008/12/10 CHKD: BELL APPR: F-SH 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
	▽=0 ▽=0.10 ▽=0.25 ▽=0.5	mm	INCH	DRAWN BY	DATE	TITLE	4:1	INCH	
		4 PLACES ±.00		MMAYO	98/10/06	GANGED INVERTED			
		3 PLACES ±.010		CHECKED BY	DATE	MODJACK ASSEMBLY			
		2 PLACES ±0.25		JROBERTS	98/10/06				
		1 PLACE ±.5		APPROVED BY	DATE				
		ANGULAR ±1/2°		JROBERTS	98/10/06	MOLEX INCORPORATED			
				MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
				N/A		SD-44248-001		5 OF 6	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE D THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



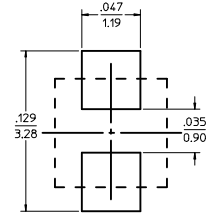
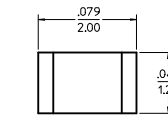
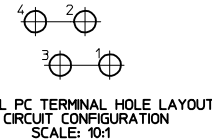
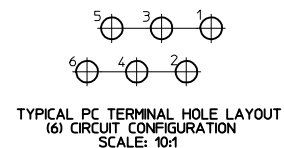
6 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



4 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



- NOTES:
- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH SHIELDING OPTION INCLUDED
 - 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
 - 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

REV	DESCRIPTION	QUALITY SYMBOLS		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	TITLE
		mm	INCH	4 PLACES ±---	3 PLACES ±---	2 PLACES ±0.25	1 PLACE ±---				
1	SEE SHEET 1	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
2	DRWN:KLOSTERMEIER 2008/12/10	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
3	CHKD:IBELL 2008/12/10	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
4	APPR:FSMTH 2008/12/10	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
5	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
6	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
7	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
8	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
9	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
10	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
11	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
12	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
13	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
14	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
15	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
16	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
17	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
18	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
19	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY
20	REV	mm	INCH	±.010	±.010	±.010	±.010	4:1	INCH	THIRD ANGLE PROJECTION	GANGED INVERTED MODJACK ASSEMBLY

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А